506291113 10/06/2020

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6337861

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
ATSUSHI OKIMURA	05/25/2020
TATSUMI KONNO	09/03/2020
WATARU NISHII	11/29/2019
YUJI NAKANO	12/03/2019
HIROSHI IZAWA	12/03/2019
HIROMI TANIGUCHI	12/03/2019

RECEIVING PARTY DATA

Name:	TS TECH CO., LTD.
Street Address:	7-27, SAKAECHO 3-CHOME
City:	ASAKA-SHI, SAITAMA
State/Country:	JAPAN
Postal Code:	3510012

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16338249

CORRESPONDENCE DATA

Fax Number: (612)455-3801

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: (612) 455-3800 mwilkie@hsml.com Email:

Correspondent Name: HAMRE, SCHUMANN, MUELLER & LARSON, P.C.

Address Line 1: 45 SOUTH SEVENTH STREET

Address Line 2: **SUITE 2700**

Address Line 4: MINNEAPOLIS, MINNESOTA 55402

ATTORNEY DOCKET NUMBER:	20144.0075USWO
NAME OF SUBMITTER:	MASAKO YOSHIDA
SIGNATURE:	/Masako Yoshida/
DATE SIGNED:	10/06/2020

Total Attachments: 12
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ASSIGNMENT OF PATENT APPLICATION

WHEREAS,

- 1. Atsushi Okimura residing at c/o TS TECH CO., LTD., 118-1 Oaza Ota Takanezawa-machi, Shioya-gun, Tochigi, 3291217 Japan and a citizen of Japan
- 2. Tatsumi Konno residing at c/o TS TECH CO., LTD., 118-1 Oaza Ota Takanezawa-machi, Shioya-gun, Tochigi, 3291217 Japan and a citizen of Japan
- 3. Wataru Nishii residing at c/o TS TECH CO., LTD., 118-1 Oaza Ota Takanezawa-machi, Shioya-gun, Tochigi, 3291217 Japan and a citizen of Japan
- 4. Yuji Nakano residing at c/o TS TECH CO., LTD., 118-1 Oaza Ota Takanezawa-machi, Shioya-gun, Tochigi, 3291217 Japan and a citizen of Japan
- 5. Hiroshi Izawa residing at c/o TS TECH CO., LTD., 118-1 Oaza Ota Takanezawa-machi, Shioya-gun, Tochigi, 3291217 Japan and a citizen of Japan
- 6. Hiromi Taniguchi residing at c/o TS TECH CO., LTD., 118-1 Oaza Ota Takanezawa-machi, Shioya-gun, Tochigi, 3291217 Japan and a citizen of Japan

(hereinafter called "THE UNDERSIGNED") have made an invention and have executed an application for Letters Patent of the United States for this invention entitled SEAT;

and

WHEREAS TS TECH CO., LTD. (hereinafter "ASSIGNEE") a corporation organized under the laws of Japan and having an office and place of business at 7-27, Sakaecho 3-chome, Asaka-shi, Saitama 3510012, Japan wishes to acquire the entire right, title and interest in and to said invention and patent application and any Letters Patent to be obtained therefor:

NOW, THEREFORE, for and in consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, THE UNDERSIGNED hereby sell, assign, and transfer to the ASSIGNEE, its successors, legal representative and assigns, the entire right, title and interest for the United States in and to the invention disclosed in said application, and in and to said application, as well as to all divisions, continuations, or renewals thereof, all Letters Patent which may be granted therefrom, and all reissues or extensions of such patents, and THE UNDERSIGNED hereby authorize and request the Commissioner of Patents of the United States to issue all Letters Patent for said invention to the ASSIGNEE of the entire right, title and interest in and to the same, in accordance with the terms of this instrument.

THE UNDERSIGNED hereby agree that THE UNDERSIGNED, their executors and legal representatives will make, execute and deliver (without charge but at the expense of the ASSIGNEE) any and all other instruments in writing including any and all further application papers, affidavits, assignments and other documents, and will communicate to said ASSIGNEE, its successors and representatives all facts known to the

THE UNDERSIGNED represent and agree with said ASSIGNEE, its successors and assigns, that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to others by the UNDERSIGNED, and that full right to convey the same as herein expressed is possessed by the UNDERSIGNED.

IN TESTIMONY WHEREOF, THE UNDERSIGNED have hereunto set their hand on the dates indicated below.

Atsushi	Ofimura	May 25, 2020
1. Signature	Atsushi Okimura	Date
2. Signature	Tatsumi Konno	Date
3. Signature	Wataru Nishii	Date
4. Signature	Yuji Nakano	Date
5. Signature	Hiroshi Izawa	Date
6. Signature	Hiromi Taniguchi	Date

ASSIGNMENT OF PATENT APPLICATION

WHEREAS,

- Atsushi Okimura residing at c/o TS TECH CO., LTD., 118-1 Oaza Ota Takanezawamachi, Shioya-gun, Tochigi, 3291217 Japan and a citizen of Japan
- 2. Tatsumi Konno residing at c/o TS TECH CO., LTD., 118-1 Oaza Ota Takanezawa-machi, Shioya-gun, Tochigi, 3291217 Japan and a citizen of Japan
- 3. Wataru Nishii residing at c/o TS TECH CO., LTD., 118-1 Oaza Ota Takanezawa-machi, Shioya-gun, Tochigi, 3291217 Japan and a citizen of Japan
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- 6. Hiromi Taniguchi residing at c/o TS TECH CO., LTD., 118-1 Oaza Ota Takanezawa-machi, Shioya-gun, Tochigi, 3291217 Japan and a citizen of Japan

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IN TESTIMONY WHEREOF, THE UNDERSIGNED have hereunto set their hand on the dates indicated below.

1, Signature	Atsushi Okimura	Date
Tatsum	i kanno	September 3,2020
2. Signature	Tatsumi Konno	Date
3. Signature	Wataru Nishii	Date
4. Signature	Yuji Nakano	Date
5. Signature	Hiroshi Izawa	Date
6. Signature	Hiromi Taniguchi	Date

ASSIGNMENT OF PATENT APPLICATION

WHEREAS.

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- 6. Hiromi Taniguchi residing at c/o TS TECH CO., LTD., 118-1 Oaza Ota Takanezawa-machi, Shioya-gun, Tochigi, 3291217 Japan and a citizen of Japan

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IN TESTIMONY WHEREOF, THE UNDERSIGNED have hereunto set their hand on the dates indicated below.

1. Signature	Atsushi Okimura	Date
2. Signature	Tatsumi Konno	Date
Wa Taru 3. Signature	Nishii Wataru Nishii	November, 29, 2019 Date
4. Signature	Yuji Nakano	Date
5. Signature	Hiroshi Izawa	Date
6. Signature	Hiromi Taniguchi	Date

ASSIGNMENT OF PATENT APPLICATION

WHEREAS,

- Atsushi Okimura residing at c/o TS TECH CO., LTD., 118-1 Oaza Ota Takanezawamachi, Shioya-gun, Tochigi, 3291217 Japan and a citizen of Japan
- 2. Tatsumi Konno residing at c/o TS TECH CO., LTD., 118-1 Oaza Ota Takanezawa-machi, Shioya-gun, Tochigi, 3291217 Japan and a citizen of Japan
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1. Signature	Atsushi Okimura	Date
2. Signature	Tatsumi Konno	Date
3. Signature	Wataru Nishii	Date
4. Signature	Hancons Yuji Nakano	<u>December 3, 2019</u> Date
5. Signature	Hiroshi Izawa	Date
6. Signature	Hiromi Taniguchi	Date

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3. Signature	Wataru Nishii	Date
4. Signature	Yuji Nakano	Date
Idiroshi 5. Signature	Uzawa_ Hiroshi Izawa	December 3,201 Date
6. Signature	Hiromi Taniguchi	Date

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3. Signature	Wataru Nishii	Date
4. Signature	Yuji Nakano	Date
5. Signature	Hiroshi Izawa	Date
Hiromi	Tanigachi	December 3. 2019
6. Signature	Hiromi Taniguchi	Date

PATENT REEL: 053989 FRAME: 0966

RECORDED: 10/06/2020